#### 502002518 07/26/2012

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Huang-Yu CHEN	06/27/2012
Tsong-Hua OU	07/05/2012
Ken-Hsien HSIEH	07/05/2012
Chin-Hsiung HSU	06/27/2012

## RECEIVING PARTY DATA

Name:	Taiwan Semiconductor Manufacturing Co., Ltd.
Street Address:	No. 8, Li-Hsin Road 6
Internal Address:	Science-Based Industrial Park
City:	Hsin-Chu
State/Country:	TAIWAN
Postal Code:	300-77

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13535705

## CORRESPONDENCE DATA

Fax Number: 2156894905 215-979-1000 Phone:

jsjiulianti@duanemorris.com Email:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

DUANE MORRIS LLP (TSMC) IP DEPARTMENT Correspondent Name:

Address Line 1: 30 SOUTH 17TH STREET

Address Line 4: PHILADELPHIA, PENNSYLVANIA 19103-4196

ATTORNEY DOCKET NUMBER: 2012.0149/1085.01028 NAME OF SUBMITTER: Steven E. Koffs

Total Attachments: 3

source=ExecutedAssign#page1.tif source=ExecutedAssign#page2.tif source=ExecutedAssign#page3.tif

REEL: 028641 FRAME: 0664

**PATENT** 

chembye 2012-06-27 08:27:53

Serial No. 13/535,705 filed June 28,2012

ATTORNEY DOCKET NO.: 2012.0149/1085.01028

# ASSIGNMENT AND AGREEMENT

For value received, we, Huang-Yu CHEN, Tsong-Hua OU, Ken-Hsien HSIEH and Chin-Hsiung HSU, hereby transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to LAYOUT METHOD AND SYSTEM FOR MULTI-PATTERNING INTEGRATED CIRCUITS, described in a non-provisional patent application, and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

-1-

DM2\3620193.1

### 7

# ATTORNEY DOCKET NO.: 2012.0149/1085.01028

We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: 2012/06/27

Huang-Yu Chen
Huang-Yu CHEN

Residence:

No. 403, Xuefu E. Road, Zhudong Township, Hsinchu County 310, Taiwan, R.O.C.

Inventor No. 2

Dated: >012/07/05

Tsong-Hua Ou Tsong-Hua OU

Residence:

4F., No. 76, Hualing Street, Shihlin District, Taipei City 111, Taiwan, R.O.C.

Inventor No. 3

Dated: >2/2/-7/17

<u>Ken-Hijen Heigh</u> Ken-Hsien HSIEH

Residence:

5F., No. 49, Section 2, Roosevelt Road, Da-an District, Taipei City 106, Taiwan, R.O.C.

-2-

DM2\3620193.1

shenhye 2012-06-27 08:27:53

ATTORNEY DOCKET NO.: 2012.0149/1085.01028

Inventor No. 4

Dated: 2012 (06/21)

Chin-Heiung HSU

Residence:

No. 207-6, 12<sup>th</sup> Neighborhood, Lunping Village, Guanyin Township, Taoyuan County 32846, Taiwan, R.O.C.

- 3 -

DM2\3620193.1

PATENT REEL: 028641 FRAME: 0667

**RECORDED: 07/26/2012**